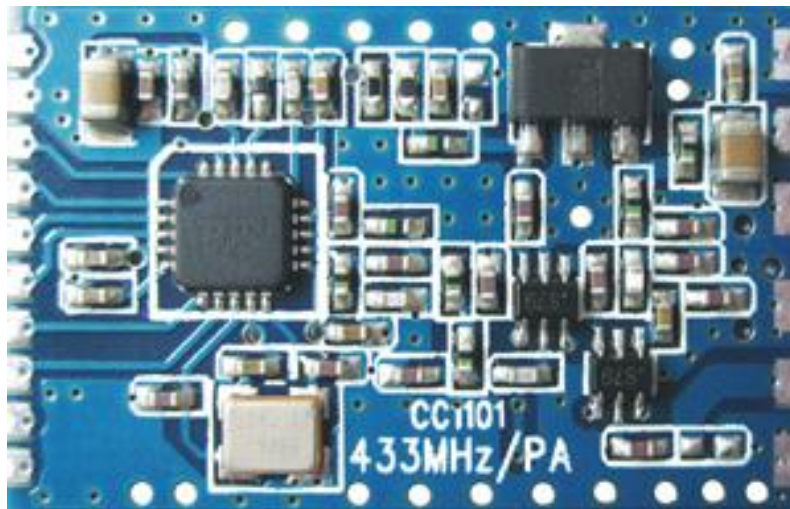


VT-CC1101HPA-868/915M Wireless Module User Guide



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General Description

VT-CC1101HPA-868/915M is based on RF Transceiver CC1101 of TI Chipcon, it's a small size and ultra low power UHF wireless module. CC1101 is a low cost true single chip UHF transmitter designed for very low power wireless applications. The circuit is mainly intended for the ISM (Industrial, Scientific and Medical) and SRD (Short Range Device) frequency bands at 315, 433, 868 and 915 MHz, The MAX RF output power can be set as high as +10dBm, with data rate as high as 500Kbps. The module integrated many RF functions and PA to make the maximum output power up to +30dBm. Customer can use it conveniently and reducing your development time.

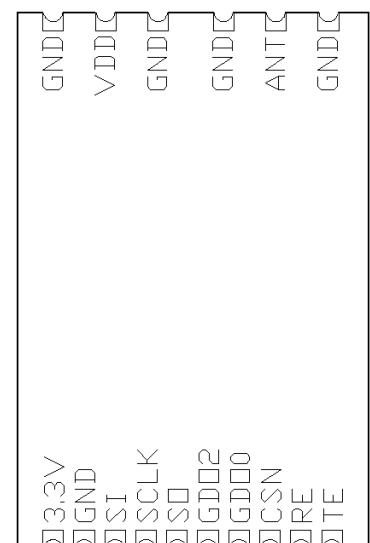
Features

- Central frequency is 868MHz, Frequency bands :779~928MHz
- Programmable output power up to +30dBm for all supported frequencies, the communication distance is above 2000m in sight .
- High receiver sensitivity down to -110dBm(at 2.4Kbps data rate)
- Programmable baseband modulator with GFSK/2-FSK/ASK/OOK/MSK
- Programmable data rate 1.2~500Kbps
- 64-byte TX data FIFO
- Optional Forward Error Correction with Interleaving
- Support carrier sense and digital RSSI output
- Low current consumption with receive mode <22mA, transmit mode at +30dBm output power <250mA
- Low current consumption at power down state <1uA
- Wake-on-radio functionality for automatic low-power RX polling
- Integrated analog temperature sensor
- Efficient SPI interface, All registers can be programmed with one “burst” transfer
- Small dimension: 26.0mm×17.0mm×2.4 mm
- Operating supply voltage: 3.0~3.6V DC, PA supply voltage: 3.0~3.6V DC



Applications

- Logistics Tracking System, Warehouse patrol, Electronic label.
- Replace RS232 and RS485 in data transmission
- Industrial monitoring and control in data acquisition
- AMR – Automatic Meter Reading
- Home and building automation
- Consumer Electronics products of wireless control
- Wireless alarm and security systems
- Wireless sensor networks



General Characteristics

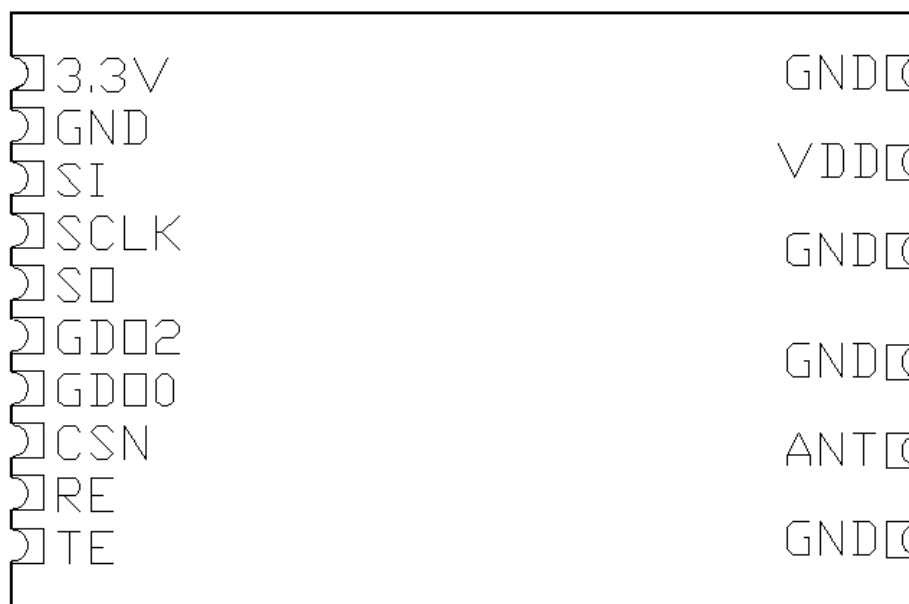
Test operating conditions: Ta=25 ℃, VCC=3.3V if nothing else stated.

Parameter	Type	Condition/Note
Operating supply voltage	DC 3.0~3.6V	PA voltage: DC 3.0~9.0V
Central frequency	868MHz	Can be programmable to other frequency in bands 779~928MHz
Frequency accuracy	±10KHz	
Modulation format	GFSK/2-FSK/ASK/OOK/M SK	Programmable
Transmit power	-10~+30dBm	Programmable
TX current consumption	<250mA	Po=30dBm
Receiver sensitivity	-110dBm	2.4Kbps
RX current consumption	<22mA	
Sleep State current consumption	<1uA	Refer to IC operation states
Data rate	1.2~500Kbps	Programmable
Spurious emissions and harmonics	< -30dBm	TX power +10dBm.
Communication distance	>2000m	2.4kBaud data rata, +30dBm output power.
Antenna impedance	50ohm	
Operating temperature	-20~+85 ℃	
Storage temperature range	-50~+125 ℃	
Dimension	26.0 mm×17.0 mm×2.4mm	See more in PCB description

Note:

1. The module transmission data rate will affect Transmission distance ,the higher the data rate , the closer the distance, and the lower the receiving sensitivity.
2. The supply voltage to the module will affect TX power, in the operating supply voltage range, the lower the voltage, the lower the TX power.
3. The module central frequency will change as the operating temperature change, use it under suggest temperature, the module can work well.
4. The antenna will strongly affect the communication distance, please select matched antenna and connect it correctly.
5. The module mount will affect the communication distance.

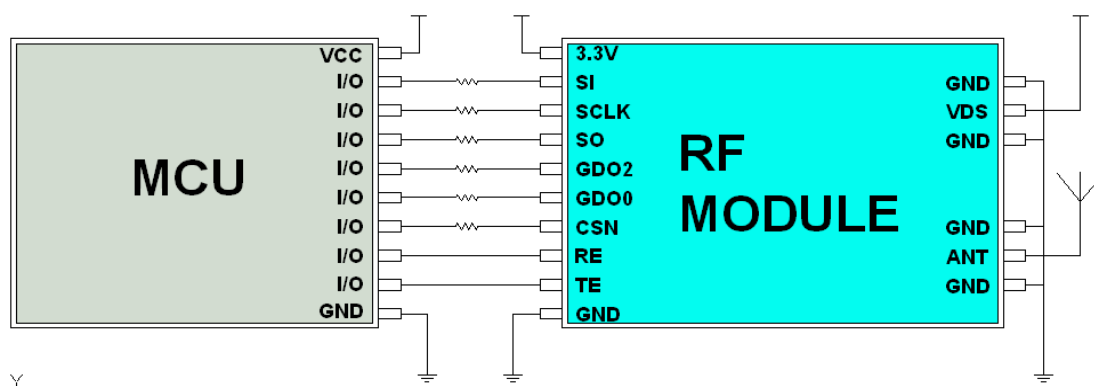
PCB Description



Pin Configuration

Pin name	Pin type	Description
3.3V	Power(Analog)	3.0 V - 3.6 V analog power supply connection.
GND	Ground	Connect to the system ground.
SI	Digital Input	Serial configuration interface, data input.
SCLK	Digital Input	Serial configuration interface, clock input.
SO	Digital Output	Serial configuration interface, data output. Optional general output pin when CSN is high.
GDO2	Digital I/O	Programmable Clock output, down-divided from XOSC
GDO0	Digital I/O	Programmable Clock output, down-divided from XOSC.
CSN	Digital Input	Serial configuration interface, chip select, active low.
RE	Digital Input	RX state: RE=0 (Low) , TE=1 (High) TX state: RE=1 (High) , TE=0 (Low)
TE	Digital Input	
VDD	Power(Analog)	DC voltage from 3.0~9V input
ANT	RF I/O	RF output signal from PA, connect to the Antenna.

Circuit Interface



Note:

1. The module power supply voltage range is DC 3.0~3.6V, the PA supply voltage is DC 3.0~9.0V, above DC 3.6V, the module will damage. It is recommended work at DC 3.3 V, the PA supply voltage consider the application condition.
2. The module interface use half circle pad to soldering on the system PCB board, the GND must soldering to the system digital GND reliably.
3. The antenna must the get to the module's ANT pin as close as possible.
4. The MCU which don't have integrated SPI interface can also control the module, use the normal I/O port to work like SPI timing to read and write. The SPI data rate is below 10MHz.
5. The interface can connect directly to the MCU which use 3.3V power supply, there is no need serial resistor. If the I/O is open-drain, the pull-up resistor will be added. When connect to the MCU which use 5V power supply, the MCU's I/O output current beyond 10 mA, a 2~5k ohm resistor will be series to divide the voltage, or it will damage the module.
6. The module's pin GDO0 and GDO2 are general digital I/O ports, they can be programmable to produce trigger signal or clock output.
7. The PA control voltage have an effect on the communicate distance and power consumption. In transmit mode, set TE=0 and RE=1; in receive or sleep mode, set TE=1 and RE=0.
8. In the multiple channel application, the channel spacing is recommended to set as 1MHz, or there will be a same frequency interference.
9. The module TX power and current consumption reference to the PA supply voltage list in the table below:

PA Voltage VDD	Output Power (dBm)	Current (mA)
3.0V	21.63	97
3.6V	22.98	111
4.5V	24.61	132
5.0V	25.34	142
6.0V	26.52	161
7.0V	27.33	176
7.5V	28.11	185
9.0V	28.71	204

Operation States

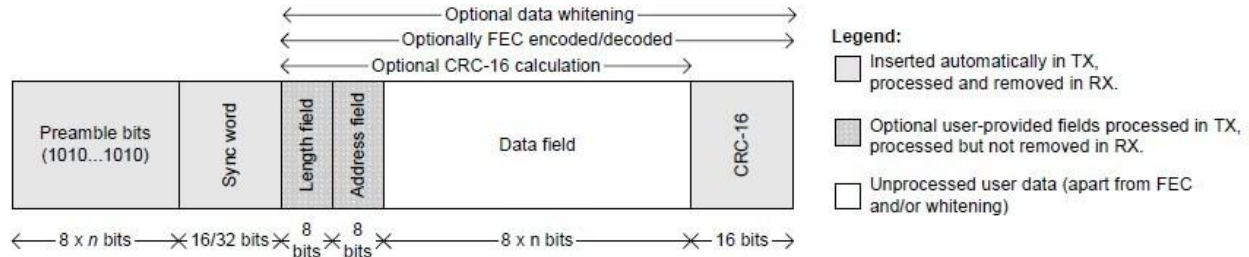
CC1101's operation states contain: Sleep State, Idle State, Active State, Sleep State is the lowest power mode. After wake up from Sleep State, the module get into Idle State. Except the Sleep State, each state can be switch by SPI interface, also programmed to auto-switch. CC1101's radio control state diagram is shown as below, for detail information in the CC1101 datasheet.



Data Transmission

The CC1101 contains a 64 byte FIFO for data to be transmitted, built-in hardware support for packet oriented radio protocols, e.g. Preamble bytes, Synchronization Word, Whitening the data, CRC checksum, Interleave and Forward Error Code, Address checksum. The SPI interface is used for sending command control and writing to the TX FIFO.

The format of the data packet can be configured and consists of the following figure:

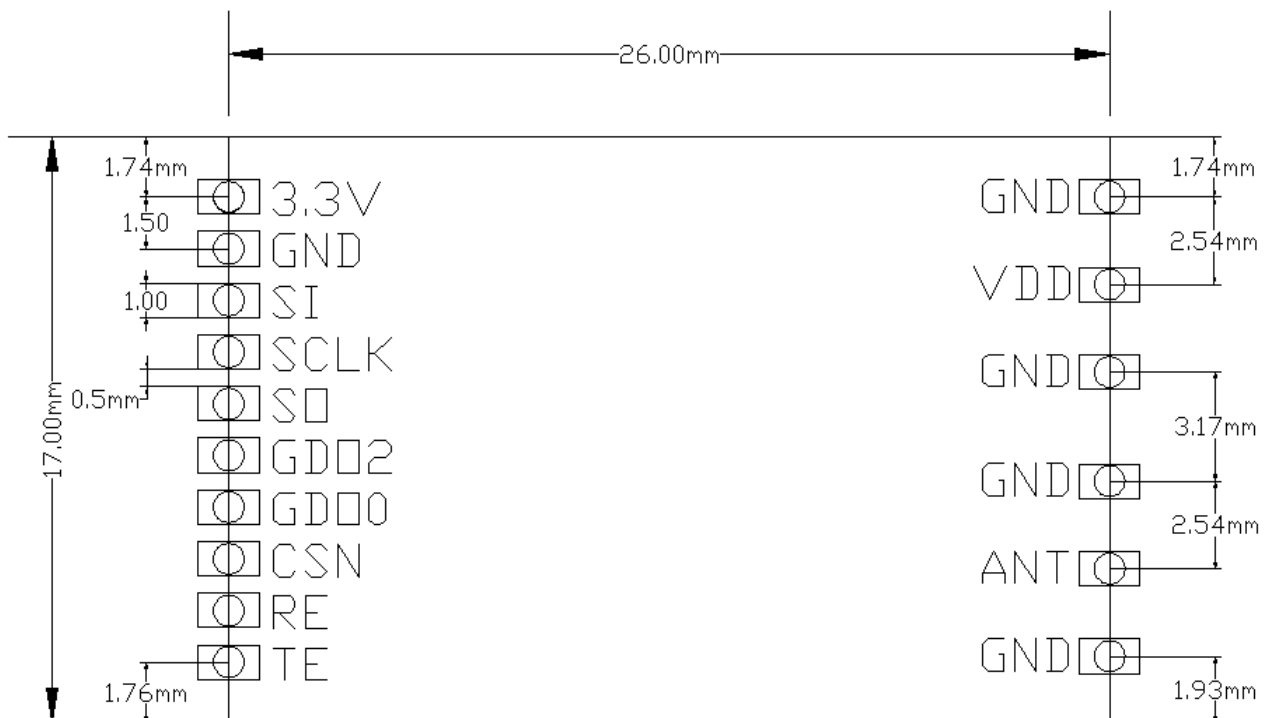


In addition, CC1101 supports fixed packet length protocols, variable packet length protocols and infinite packet length. Details refer to the CC1101 datasheet.

Configuration Registers

The configuration of CC1101 can be done with software SmartRF Studio7. Complete descriptions of the registers are given in the CC1101 datasheet. We can provide evaluation board and demo code to the customer to develop and evaluate the module's capability.


Dimension



Antenna

We can provide antenna match to the module. And if there is some special requirements to satisfy, we can coordinate with you to select antenna, match antenna to the module in order to make the product work well.

Some recommend antennas as the table below.

<p>Spring antenna (Standard) Characteristic: small size, low cost, embedded conveniently.</p>	
<p>SMA rubber antenna (Optional) Characteristic: medium-scale, low cost, high gain</p>	
<p>Magnetic Mount Antenna (Optional) Characteristic: high gain, Magnetic Mount , suitable for mount on iron box.</p>	

Note: Standard is for free, optional need another payment and the cost refer to the antenna price.

Questions and Answers

Description	Reason and Solution
Can't communication	<ol style="list-style-type: none"> 1. The power supply connect not well, check the module VCC whether it is out of maximum rating. 2. The signal line connect not well, check the module SPI interface. 3. The settings of the transmitter module and receiver module are not the same. Check these modules' register configuration. 4. Signal block. If the transmitter work with a high TX power, and the receiver was put at a short distance(<0.5m), maybe there is a signal block to make no communication.
Communication distance is too short	<ol style="list-style-type: none"> 1. The application environment is too bad or the antenna is shield. Put the antenna to a better place outside or higher throw a coaxial line , replace it with a higher gain antenna. 2. The work space contains a same frequency interference source, or a strong magnetic field interference, power source disturbance. Try to change the carrier frequency or get far away from the source of the disturbance. 3. The power supply is not strong. Check the voltage and the current whether it is enough.
High data error	<ol style="list-style-type: none"> 1. The power supply ripple is too big, Change the power supply. 2. Check the module register configuration, it is recommended to set as the CC1101-datasheet. 3. There is a carrier frequency interference, change the channel. 4. The antenna unmatched to the module RF interface, change another matched antenna.

Development Package:

1. CC1101 datasheet (CC1101.pdf)
2. CC1101 register configuration tool (SmartRF Studio 7 v1.4.9.zip)
3. CC1101 demo code (CC1101 Demo Code.rar)
4. Hard ware tools (TI Chipcon Evaluation Board)

Note:

1. You can get the development package above from the salesman when you order the module.
2. As version update, please refer to our latest development materials.

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